



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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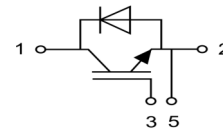
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$V_{CES} = 1200V$
$I_C = 300A$ at $T_C = 80^\circ C$
$t_{SC} \geq 10\mu sec$
$V_{CE(ON)} = 1.90V$ at $I_C = 300A$

**Single Switch IGBT with Soft Recovery Diode**  
**POWIR 62™ Package**



**Applications:**

- Industrial Motor Drive
- Uninterruptible Power Supply
- Welding and Cutting Machine
- Switched Mode Power Supply
- Induction Heating

Features	Benefits
Low $V_{CE(ON)}$ and Switching Losses	High Efficiency in a Wide Range of Applications
RBSOA Tested	Rugged Transient Performance
10μsec Short Circuit Safe Operating Area	
<b>POWIR 62™</b> Package	Industry Standard
Lead Free	RoHS Compliant, Environmental Friendly

Base Part Number	Package Type	Standard Pack	Quantity	Orderable Part Number
IRG7T300SD12B	<b>POWIR 62™</b>	Box	45	IRG7T300SD12B

**Absolute Maximum Ratings of IGBT**

$V_{CES}$	Collector to Emitter Voltage	1200	V
$V_{GES}$	Continuous Gate to Emitter Voltage	±20	V
$I_C$	Continuous Collector Current	$T_C = 80^\circ C$	300 A
		$T_C = 25^\circ C$	600 A
$I_{CM}$	Pulse Collector Current	$T_J = 175^\circ C$	600 A
$P_D$	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ C, T_J = 175^\circ C$	1800 W
$T_J$	Maximum IGBT Junction Temperature	175	°C
$T_{JOP}$	Maximum Operating Junction Temperature Range	-40 to +150	°C
$T_{stg}$	Storage Temperature	-40 to +125	°C

**Electrical Characteristics of IGBT at  $T_J = 25^\circ\text{C}$  (Unless Otherwise Specified)**

Parameter		Min.	Typ.	Max.	Unit	Test Conditions	
$V_{(BR)CES}$	Collector to Emitter Breakdown Voltage	1200			V	$V_{GE} = 0V, I_C = 4mA$	
$V_{GE(th)}$	Gate Threshold Voltage	5.0	5.8	6.5	V	$I_C = 14mA, V_{CE} = V_{GE}$	
$V_{CE(ON)}$	Collector to Emitter Saturation Voltage		1.90	2.20	V	$T_J = 25^\circ\text{C}$	$I_C = 300A, V_{GE} = 15V$
			2.20		V	$T_J = 125^\circ\text{C}$	
$I_{CES}$	Collector to Emitter Leakage Current			4	mA	$V_{GE} = 0V, V_{CE} = V_{CES}$	
$I_{GES}$	Gate to Emitter Leakage Current			400	nA	$V_{GE} = \pm 20V, V_{CE} = 0$	
$R_{Gint}$	Internal Gate Resistance		0.63		$\Omega$		

**Switching Characteristics of IGBT**

Parameter		Min.	Typ.	Max.	Unit	Test Conditions	
$t_{d(on)}$	Turn-on Delay Time		760		ns	$T_J = 25^\circ\text{C}$	$V_{CC} = 600V, I_C = 300A, R_G = 6.2 \Omega, V_{GE} = \pm 15V, \text{Inductive Load}$
			700			$T_J = 125^\circ\text{C}$	
$t_r$	Rise Time		400		ns	$T_J = 25^\circ\text{C}$	
			440			$T_J = 125^\circ\text{C}$	
$t_{d(off)}$	Turn-off Delay Time		1080		ns	$T_J = 25^\circ\text{C}$	
			1120			$T_J = 125^\circ\text{C}$	
$t_f$	Fall Time		175		ns	$T_J = 25^\circ\text{C}$	
			195			$T_J = 125^\circ\text{C}$	
$E_{on}$	Turn-on Switching Loss		20.8		mJ	$T_J = 25^\circ\text{C}$	
			27.6			$T_J = 125^\circ\text{C}$	
$E_{off}$	Turn-off Switching Loss		14.4		mJ	$T_J = 25^\circ\text{C}$	
			22.0			$T_J = 125^\circ\text{C}$	
$Q_g$	Total Gate Charge		2500		nC	$T_J = 25^\circ\text{C}$	
$C_{ies}$	Input Capacitance		41.5		nF	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz, T_J = 25^\circ\text{C}$	
$C_{oes}$	Output Capacitance		2.20				
$C_{res}$	Reverse Transfer Capacitance		1.44				
RBSOA	Reverse Bias Safe Operating Area	Trapezoid				$I_C = 600A, V_{CC} = 960V, V_P = 1200V, R_G = 15\Omega, V_{GE} = +15V \text{ to } 0V, T_J = 150^\circ\text{C}$	
SCSOA	Short Circuit Safe Operating Area	10			$\mu\text{s}$	$V_{CC} = 600V, V_{GE} = 15V, T_J = 150^\circ\text{C}$	

**Absolute Maximum Ratings of Freewheeling Diode**

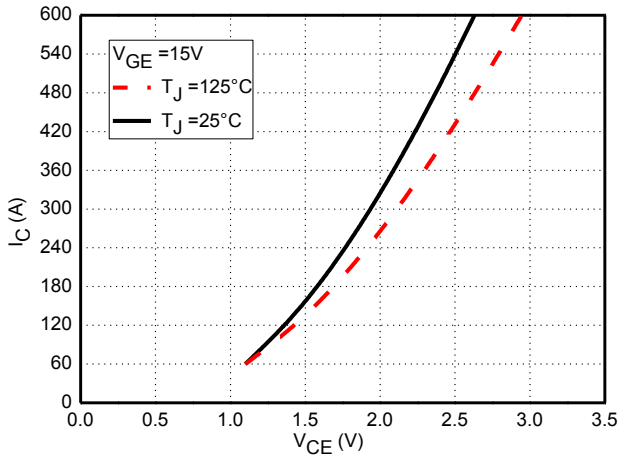
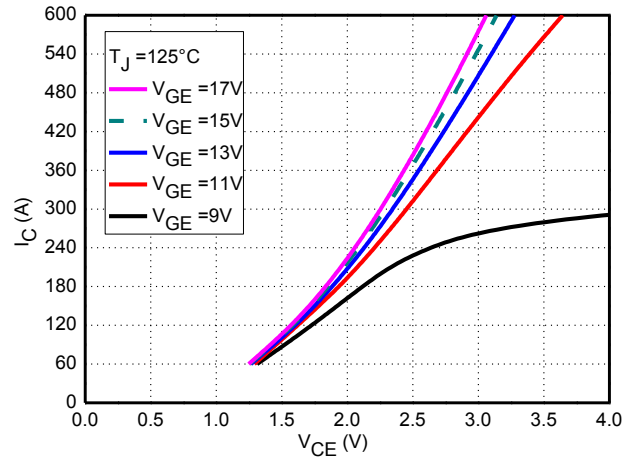
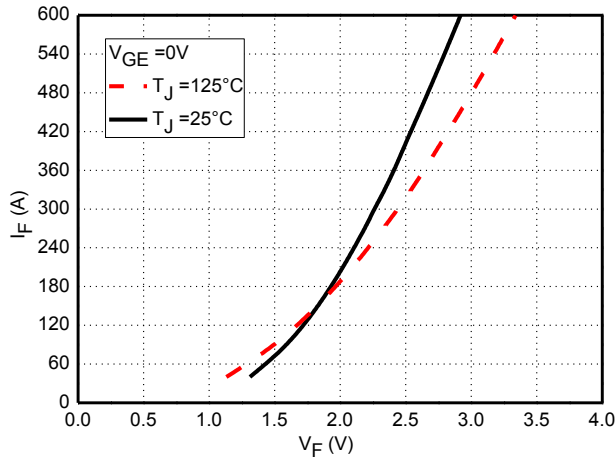
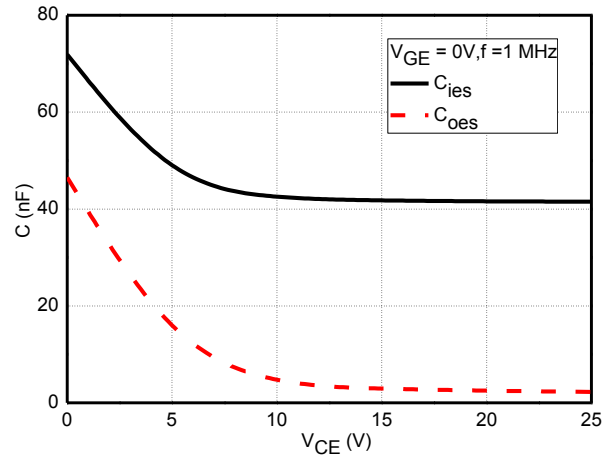
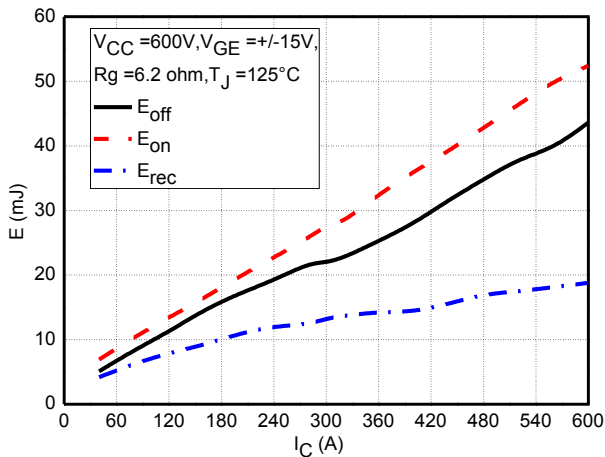
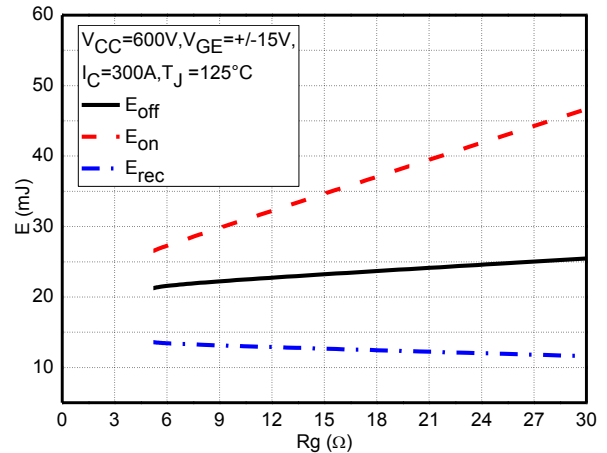
$V_{RRM}$	Repetitive Peak Reverse Voltage	1200	V
$I_F$	Diode Continuous Forward Current, $T_C = 25^\circ\text{C}$	600	A
	Diode Continuous Forward Current, $T_C = 80^\circ\text{C}$	300	
$I_{FM}$	Pulse Diode Current	600	A

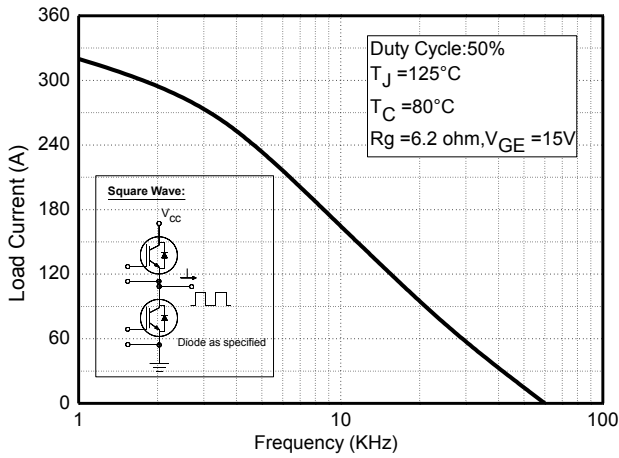
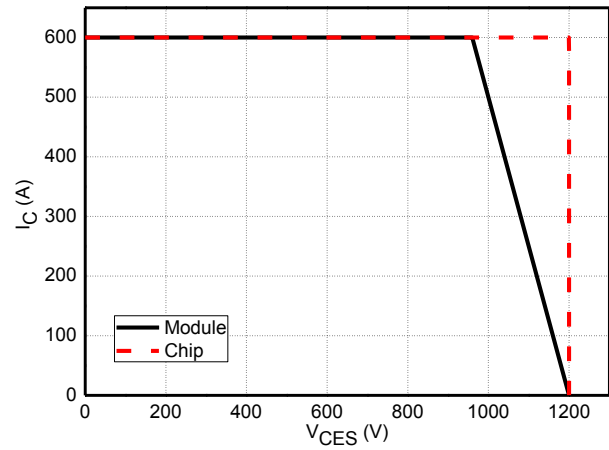
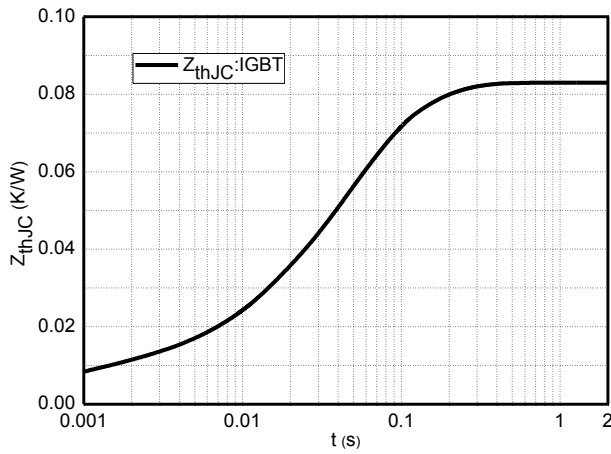
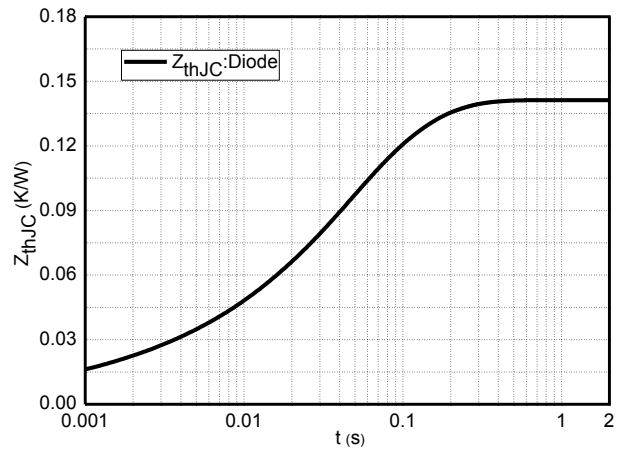
**Electrical and Switching Characteristics of Freewheeling Diode**

Parameter		Typ.	Max.	Unit	Test Conditions	
$V_F$	Forward Voltage	2.20	2.70	V	$T_J = 25^\circ\text{C}$	$I_F = 300\text{A}$ , $V_{GE} = 0\text{V}$
		2.40			$T_J = 125^\circ\text{C}$	
$I_{rr}$	Peak Reverse Recovery Current	90		A	$T_J = 25^\circ\text{C}$	$I_F = 300\text{A}$ , $di/dt = 2100\text{A}/\mu\text{s}$ , $V_{rr} = 600\text{V}$ , $V_{GE} = -15\text{V}$
		145			$T_J = 125^\circ\text{C}$	
$Q_{rr}$	Reverse Recovery Charge	10.8		$\mu\text{C}$	$T_J = 25^\circ\text{C}$	
		22.3			$T_J = 125^\circ\text{C}$	
$E_{rec}$	Reverse Recovery Energy	4.5		mJ	$T_J = 25^\circ\text{C}$	
		8.2			$T_J = 125^\circ\text{C}$	

**Module Characteristics**

Parameter		Min.	Typ.	Max.	Unit
$V_{iso}$	Isolation Voltage (All Terminals Shorted), $f = 50\text{Hz}$ , 1minute			2500	V
$R_{\theta JC}$	Junction-to-Case (IGBT)		0.082		$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case (Freewheeling Diode)		0.141		$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Case-To-Sink (Conductive Grease Applied)		0.1		$^\circ\text{C}/\text{W}$
M	Power Terminals Screw: M6	3.0		5.0	N·m
M	Mounting Screw: M6	4.0		6.0	N·m
G	Weight		310		g


**Fig.1 Typical IGBT Saturation Characteristics**

**Fig.2 Typical IGBT Output Characteristics**

**Fig.3 Typical Freewheeling Diode Characteristics**

**Fig. 4 Typical Capacitance Characteristics**

**Fig.5 Typical Switching Loss vs. Collector Current**

**Fig.6 Typical Switching Loss vs. Gate Resistance**


**Fig.7 Typical Load Current vs. Frequency**

**Fig.8 Reverse Bias Safe Operation Area (RBSOA)**

**Fig.9 Typical Transient Thermal Impedance (IGBT)**

**Fig.10 Typical Transient Thermal Impedance (Diode)**

